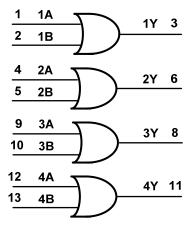


Pin Descriptions

Pin Number	Pin Name	Function
1	1A	Data Input
2	1B	Data Input
3	1Y	Data Output
4	2A	Data Input
5	2B	Data Input
6	2Y	Data Output
7	GND	Ground
8	3Y	Data Output
9	3A	Data Input
10	3B	Data Input
11	4Y	Data Output
12	4A	Data Input
13	4B	Data Input
14	V _{CC}	Supply Voltage

Logic Diagram



Function Table

Inp	Output	
Α	В	Υ
L	L	L
L	Н	Н
Н	L	Н
Н	Н	Н

Absolute Maximum Ratings (Note 4) (@TA = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V_{CC}	Supply Voltage Range	-0.5 to +7.0	V
VI	Input Voltage Range	-0.5 to +7.0	V
l _{IK}	Input Clamp Current V _I < -0.5V	-20	mA
lok	Output Clamp Current V _O < -0.5V	-20	mA
I _{OK}	Output Clamp Current V _O > V _{CC} +0.5V	25	mA
I _O	Continuous Output Current -0.5V < V _O V _{CC} +0.5V	+/- 25	mA
Icc	Continuous Current Through V _{CC}	75	mA
I _{GND}	Continuous Current Through GND	-75	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
P _{TOT}	Total Power Dissipation	500	mW

Note:

^{4.} Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.



Recommended Operating Conditions (@TA = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage		2.0	5.5	V
VI	Input Voltage		0	5.5	V
Vo	Output Voltage		0	Vcc	V
Δt/ΔV	Input Transition Rise or Fall Rate	V_{CC} = 3.0V to 3.6V		100	ns/V
ΔυΔν	input transition Rise of Fall Rate	V_{CC} = 4.5V to 5.5V		20	115/ V
T_A	Operating Free-Air Temperature		-40	+125	°C

Note: 5. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Symphol	Darameter	Toot Conditions	V	T _A = -40°0	C to +85°C	T _A = -40°C	to +125°C	Unit
Symbol	Parameter	Test Conditions \	V _{CC}	Min	Max	Min	Max	Unit
			2.0V	1.5		1.5		
V_{IH}	High-Level Input Voltage		3.0V	2.1		2.1		V
			5.5V	3.85		3.85		
			2.0V		0.5		0.5	
V_{IL}	Low-Level Input Voltage		3.0V		0.9		0.9	V
			5.5V		1.65		1.65	
	High-Level Output Voltage	I _{OH} = -50μA	2.0V	1.9		1.9		V
		I _{OH} = -50μA	3.0V	2.9		2.9		
V_{OH}		I _{OH} = -50μA	4.5V	4.4		4.4		
		I _{OH} = -4mA	3.0V	2.48		2.40		
		I _{OH} = -8mA	4.5V	3.80		3.70		
		I _{OL} = 50μA	2.0V		0.1		0.1	
		I _{OL} = 50μA	3.0V		0.1		0.1	
V_{OL}	Low-Level Output Voltage	I _{OL} = 50μA	4.5V		0.1		0.1	V
		I _{OL} = 4mA	3.0V		0.44		0.55	
		I _{OL} = 8mA	4.5V		0.44		0.55	
II	Input Current	V _I = GND to 5.5V	3.6V		±1		±2	μA
Icc	Supply Current	$V_I = GND \text{ or } V_{CC}, I_O = 0$	3.6V		20		40	μA

Operating Characteristics

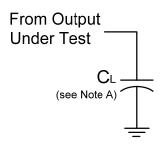
Parameter		Test	V _{CC} = 2.0V	V _{CC} = 3.3V	V _{CC} = 5V	Unit
	Parameter		Тур	Тур	Тур	Uiiit
C _{pd}	Power Dissipation Capacitance per Gate	f = 1 MHz	9.7	11.0	14.9	pF
Ci	Input Capacitance	$V_i = V_{CC} - or$ GND	4.0	4.0	4.0	pF



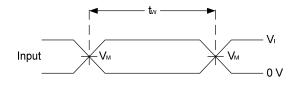
Switching Characteristics

Symbol	Parameter	Test	Test Conditions V _{CC}	1	Γ _A = +25°0	3	-40°C to	o +85°C	-40°C to	+125°C	Unit
Syllibol	Symbol Parameter	Conditions		Min	Тур	Max	Min	Max	Min	Max	Oilit
		Figure 1	3.0V to 3.6V	0.5	4.5	7.9	0.5	9.5	0.5	10.0	
	Propagation	$C_L = 15pF$	4.5V to 5.5V	0.5	3.2	5.5	0.5	6.5	0.5	7.0	20
t _{PD}	Delay A _N to Y _N	Figure 1	3.0V to 3.6V	0.5	6.0	11.4	0.5	13.0	0.5	14.5	ns
		$C_L = 50pF$	4.5V to 5.5V	0.5	4.5	7.5	0.5	8.5	0.5	9.5	

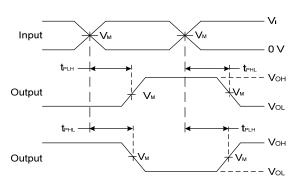
Parameter Measurement Information



V	Inp	outs	V	
V _{CC}	VI	t _r /t _f	V _M	CL
3.3V -3.6V	V _{CC}	3ns	V _{CC} /2	15pF, 50pF
4.5V to 5.5V	V _{CC}	3ns	V _{CC} /2	15pF, 50pF



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

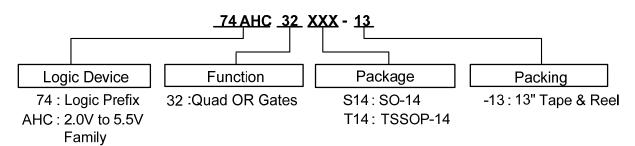
Figure 1. Load Circuit and Voltage Waveforms

Notes: A . Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 1 MHz.
- C. Inputs are measured separately one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{PD}



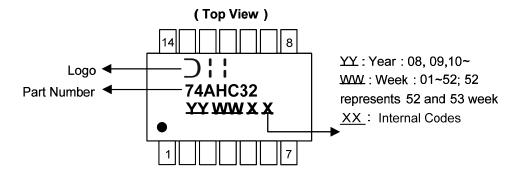
Ordering Information



Device	Backage Code	Dockoning	7" Tape	and Reel
Device	Package Code	Packaging	Quantity	Part Number Suffix
74AHC32S14-13	S14	SO-14	2500/Tape & Reel	-13
74AHC32T14-13	T14	TSSOP-14	2500/Tape & Reel	-13

Marking Information

(1) SO-14, TSSOP-14



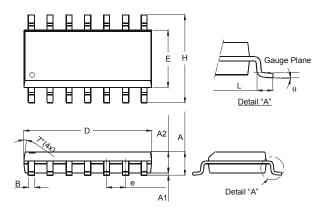
Part Number	Package
74AHC32S14	SO-14
74AHC32T14	TSSOP-14



Package Outline Dimensions (All dimensions in mm.)

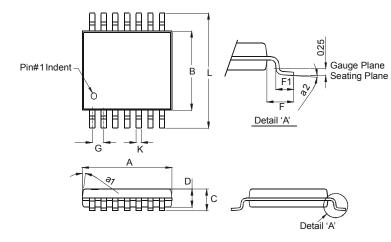
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

Package Type: SO-14



	SO-14	
Dim	Min	Max
Α	1.47	1.73
A1	0.10	0.25
A2	1.45	Тур
В	0.33	0.51
D	8.53	8.74
Е	3.80	3.99
е	1.27	Тур
Н	5.80	6.20
٦	0.38	1.27
θ	0°	8°
All Di	mensions	s in mm

Package Type: TSSOP-14



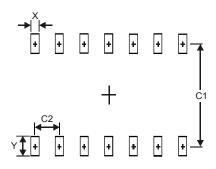
т	SSOP-14	1		
Dim	Min	Max		
a1	7° (4X)		
a2	0°	8°		
Α	4.9	5.10		
В	4.30	4.50		
O		1.2		
D	8.0	1.05		
F	1.00	Тур		
F1	0.45	0.75		
O	0.65	Тур		
K	0.19	0.30		
L	6.40			
All Dimensions in				
mm				



Suggested Pad Layout

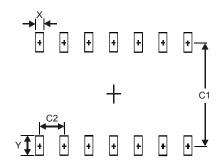
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

Package Type: SO-14



Dimensions	Value (in mm)
X	0.60
Y	1.50
C1	5.4
C2	1.27

Package Type: TSSOP-14



Dimensions	Value (in mm)
X	0.45
Y	1.45
C1	5.9
C2	0.65



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